

Semico Fab Database Update Summary First Half 2015

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Below are the column headings included in the Excel workbook accompanying this Word document. There are 896 rows in the workbook:

Status	Other NV Memory
Company	MEMS
FabName	Image Sensors
Region	Oth Sensors
Country	LED
City	LED Drivers
State/ Region	LCD Drivers
Special Substrate	Other
University	Bipolar
Development	Current Process Tech (nm)
IDM	FinFET
Foundry	Wafer Size (mm)
Process Type	450mm capable
Products	Full Capacity (w/mo)
Logic	Full Capacity (8-in Equiv/ mo)
ASSPs	Construction Start
ASICs	Initial Prod Yr
Analog	Vol Prod Yr
Discretes	Yr Closed or Closing
Passives	Empl
Opto	Total Capex (millions)
DRAM	Site Size
Mobile RAM	Total Fab Size (K sq. m)
SRAM	Cleanroom Size (K sq. m)
NAND	
NOR	